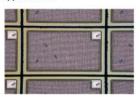


BARE DIE COMPONENTS NEWSLETTER FEBRUARY 2020



EA2M

Serial 2-Mb SPI Ultra Low-Power EEPROM with ECC for high reliability portable or battery applications.



Power MOSFET Bare die range

The Power MOSFET die range from Analog Power Inc. covers a broad spectrum of low & high voltage products.



OPA2227

High Precision, Low Noise Operational Amplifiers



SOI Full-Bridge FET Gate Driver

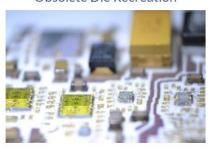
SOI FET Gate Driver for Full-Bridge / H-Bridge & Motor Control applications enhances performance + reliability.

Chip / Die Supply for Hybrids - Protec GmbH

Partnering with manufacturers and die houses

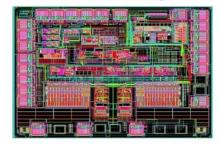
Historically Protec GmbH has a a lot of experience suppying bare die from the seminconductor manufacturers of the world to the hybrid customers in Germany, Austria and Switzerland.

Obsolete Die Recreation



Matching of die size, wire-bond configuration and like-for-like electrical performance delivers a qualified long term die solution.

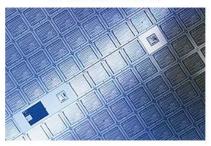
Discrete & IC Design



Suitable for low-to-medium volume or hi-rel applications. We combine technical requirement with project economics for a viable die solution.

With our new partners we are now able to provide even better service and availability over long time periods, since most of the Hybrid designs are arround for many years and our customers are facing obsolesence issues on a regular basis. With our partners we have the possibility to help our customer with obsolete die in many ways, with either die banking, or even reverse engineering. For many obsolete parts there are alternatives available from our partners.

Hi-Rel Die Products



Our standard product range covers a wide temperature range with long term availability and no mask changes guaranteed.











Unsawn Wafer

Wafer Sawn on Tape

Die in Waffle Pack

Die in Gel-Pak™

Die in Tape & Reel